

Test-beam studies on the ALICE investigator chip

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CLICdp collaboration meeting

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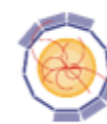
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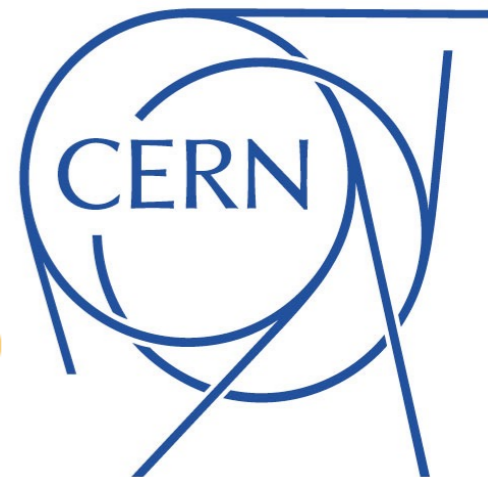
Federal Ministry
of Education
and Research



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AIDA²⁰²⁰



Outline

- Motivation of study on ALICE investigator chip
- Introduction of the ALICE investigator chip
- Test-beam data taking & analysed data
- Results
- Summary & outlook

Motivation of studies on ALICE investigator chip



Large surface silicon tracker planned for CLIC ($\sim 90\text{m}^2$):

- Need of large scale production

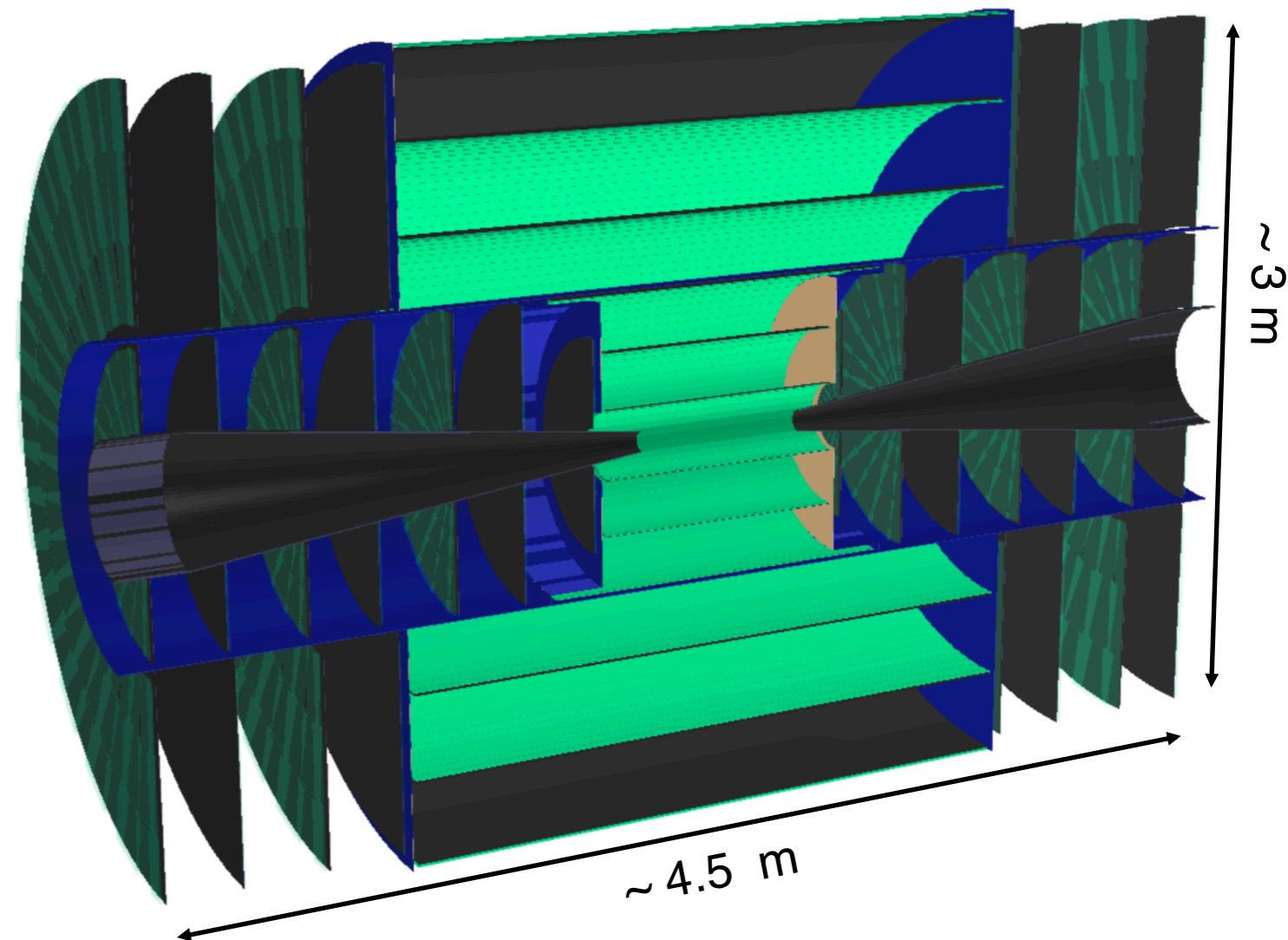
Benefit from integrated technologies:

- Monolithic technologies
- No need of bump bonding
- Reduced material budget

Benefit from synergies with ALICE collaboration:

- Test-chip developed within ALICE collaboration to investigate full analogue performance of monolithic technology chosen by ALICE
- Interesting to study feasibility of monolithic technology with respect to CLIC tracker requirements (time slicing of 10 ns, single point resolution of $\sim 7\ \mu\text{m}$)

CLIC tracker layout:

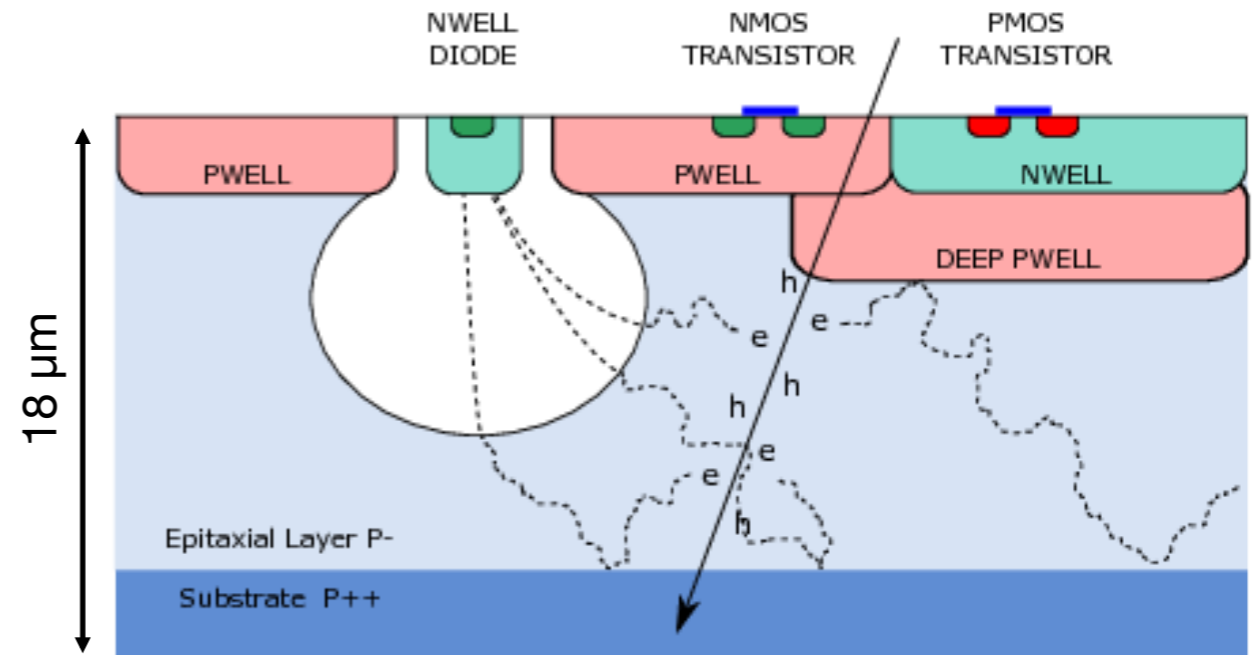


The ALICE investigator chip



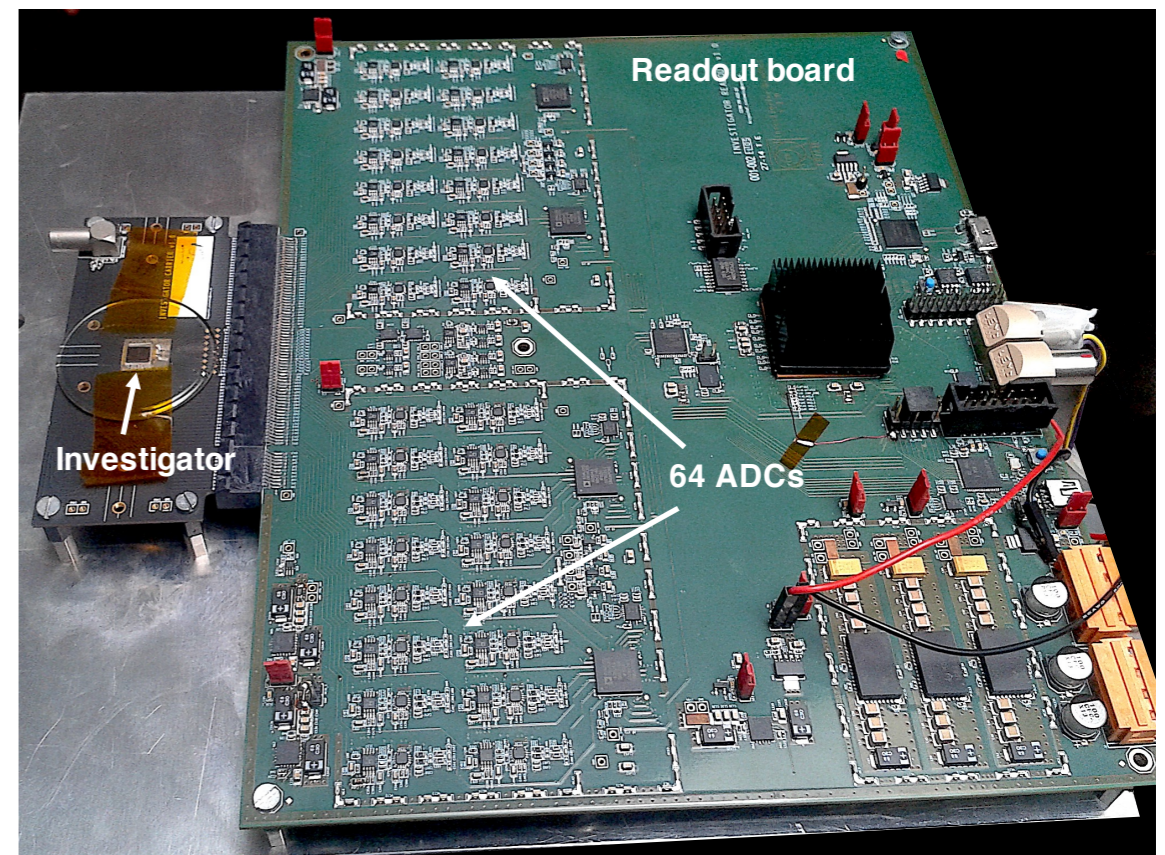
ALICE INVESTIGATOR, **monolithic HR-CMOS test-chip** (W. Snoeys, J. W. Van Hoorne et. al.):

- Developed by the ALICE collaboration to test analogue performance
- 180 nm High Resistivity (HR) CMOS process
- 15-40 μm thick epitaxial layer (1-8 $\text{k}\Omega\text{cm}$)
- **134 mini-matrices with different pixel layouts**
- 8x8 pixel matrix per mini-matrix
- **Optimisation of collection-diode geometry**
→ Minimise capacitance (~ 2 fF) → fast timing (\sim ns)



External readout (designed by K. M. Sielewicz):

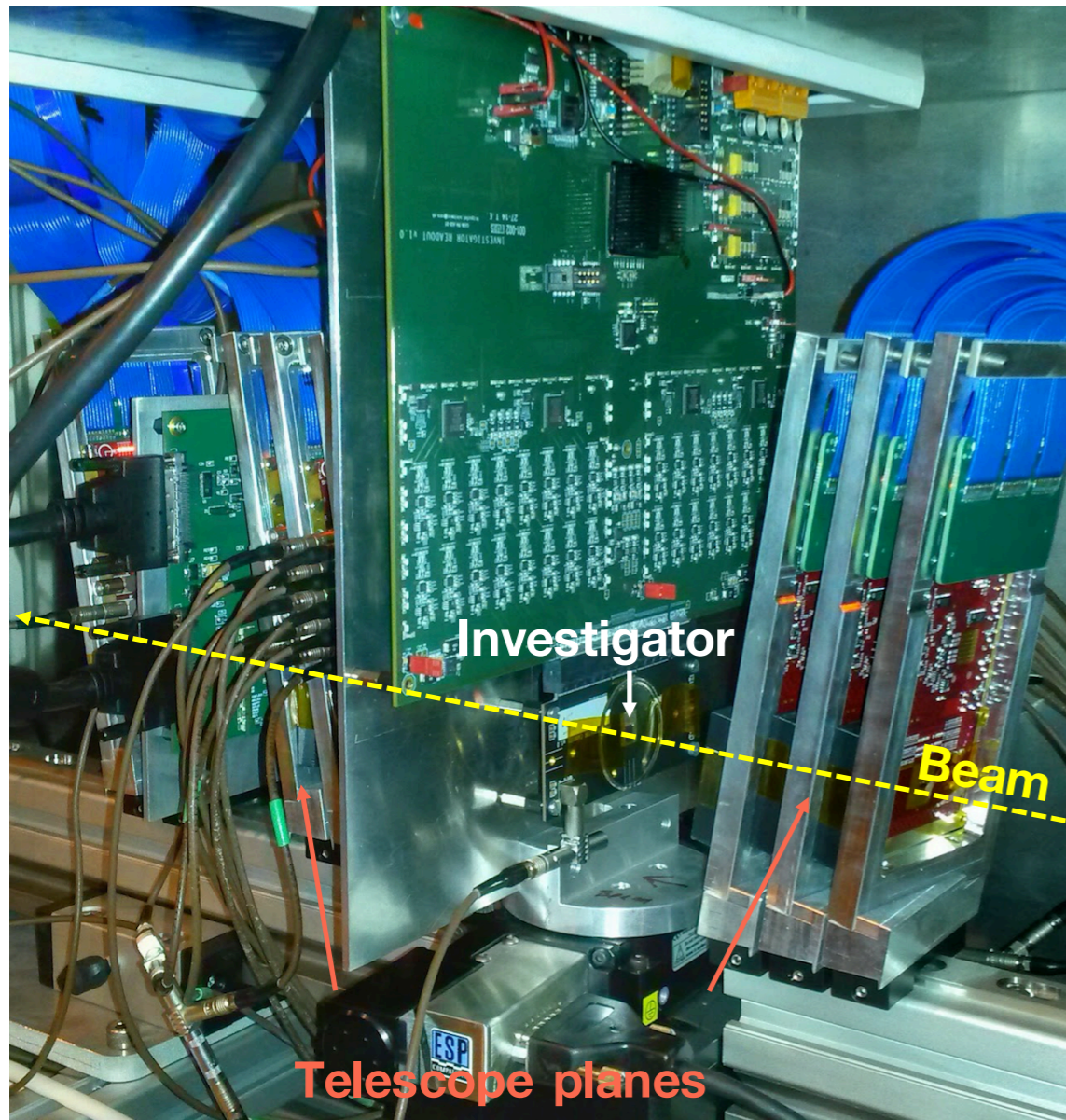
- Selectable mini-matrix
→ Connected to readout
→ **64 ADCs to read out full waveform of each pixel**
- **65 MHz sampling clock**
→ Limits achievable accuracy of timing resolution



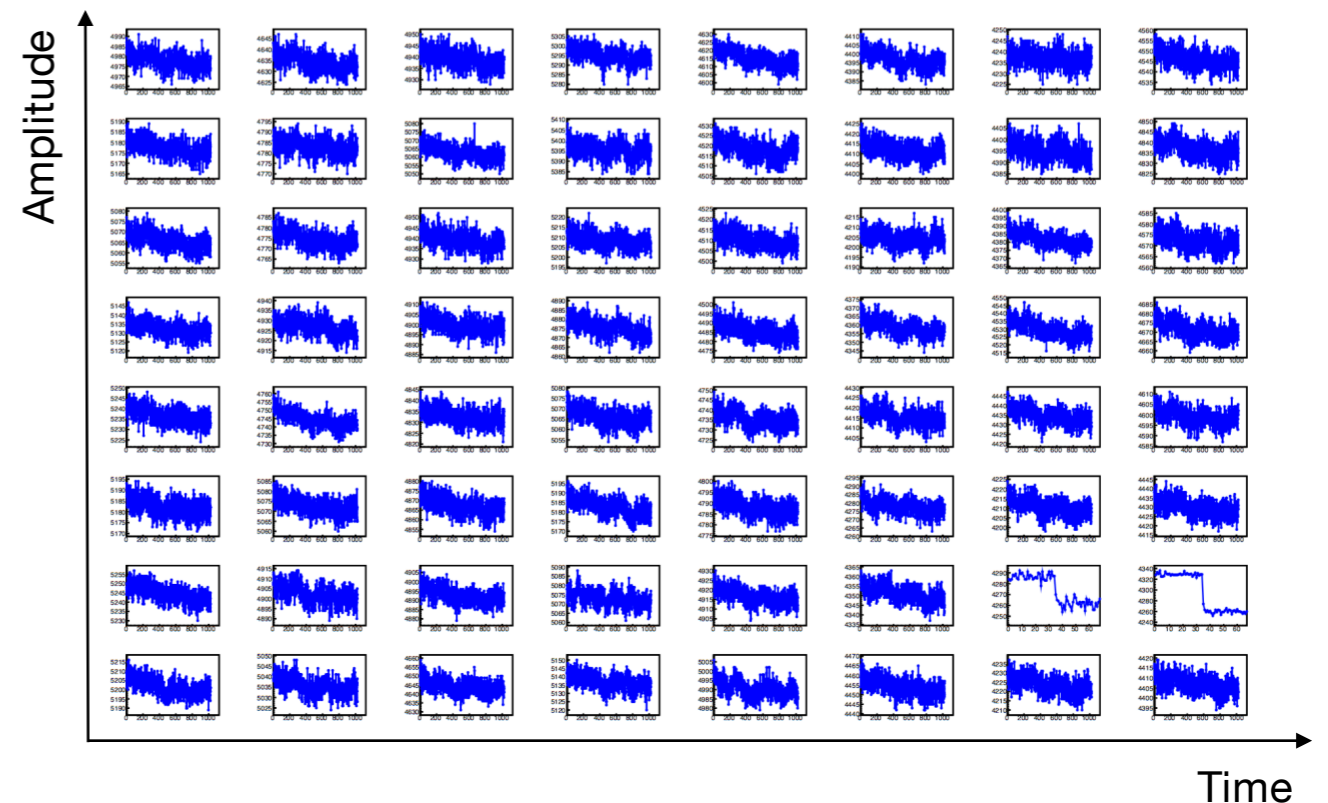
Test-beam data taking

ALICE INVESTIGATOR integrated in CLICdp Timepix3 telescope at SPS beam-line:

Mechanical integration of investigator in Timepix3 telescope setup:



Integration of investigator data in telescope software:



- If a hit gets recorded in the investigator:
 - Read out of waveform of all pixels
 - Sent trigger package to telescope planes
 - Used for offline synchronisation

→ Benefit from good single point ($\sim 2 \mu\text{m}$) and timing ($\sim \text{ns}$) resolution of Timepix3 telescope

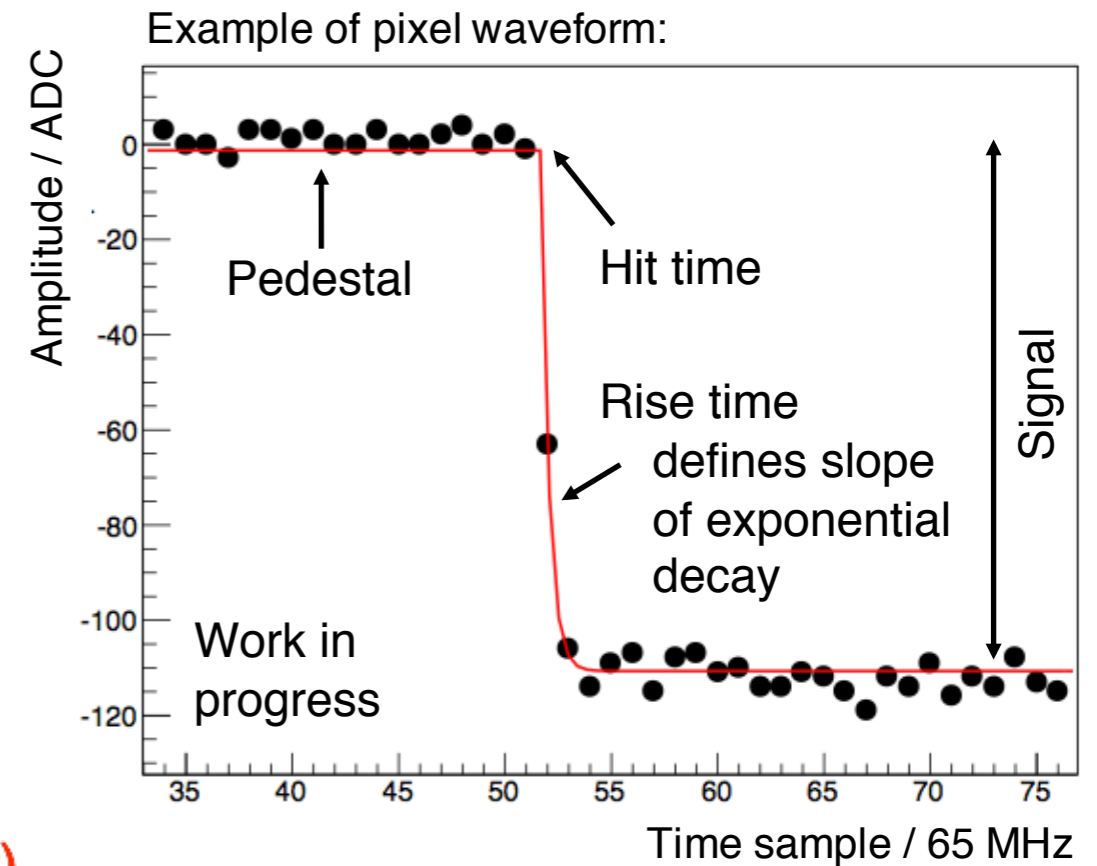
Event reconstruction



Basic reconstruction and definition of observables:

- Signal defined as magnitude of amplitude drop
- Noise defined as RMS of fluctuation around baseline
- Cut on $S/N > 8$
- Fit exponential function $f(t)$ to waveform of each pixel to extract timing:

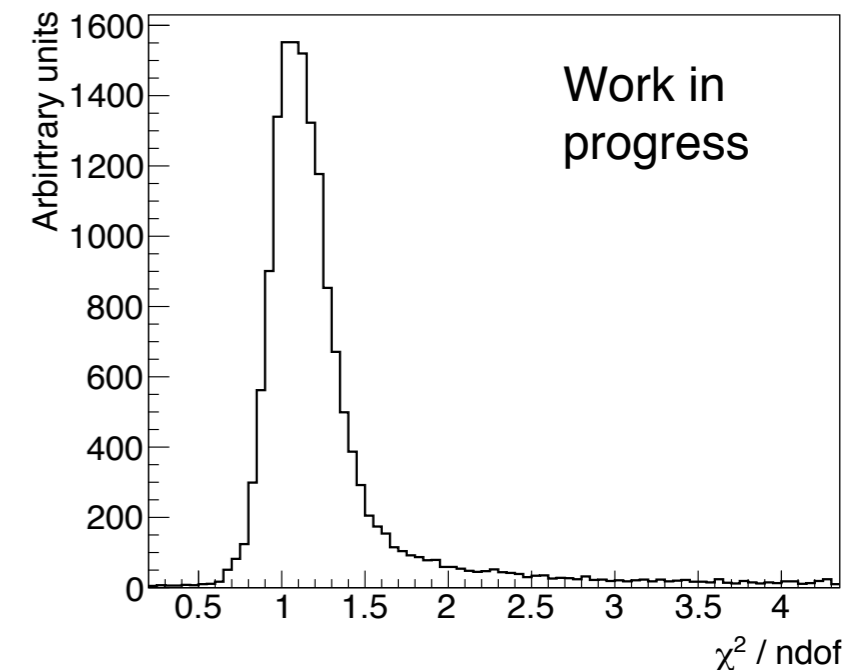
$$f(t) = \begin{cases} \text{Pedestal} & t \leq t(\text{hit}) \\ \text{Pedestal} + \text{Signal} * (e^{[t-t(\text{hit})] / t(\text{rise})} - 1) & t > t(\text{hit}) \end{cases}$$



Further quality cuts:

- Cut on χ^2 / ndof of waveform fit \rightarrow only for timing observables
- Track-cluster distance $< 100 \mu\text{m}$
- Masking of edge pixels

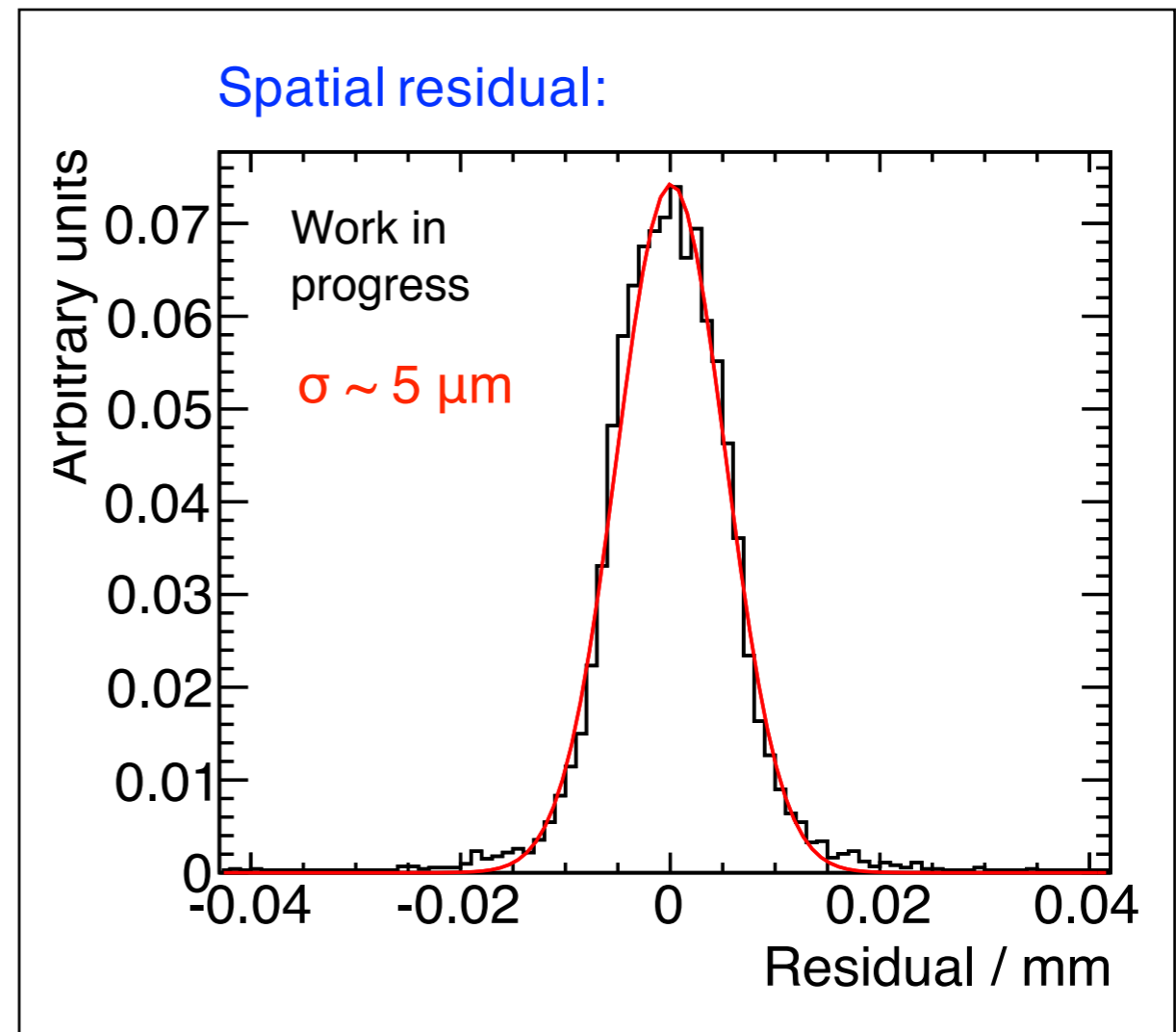
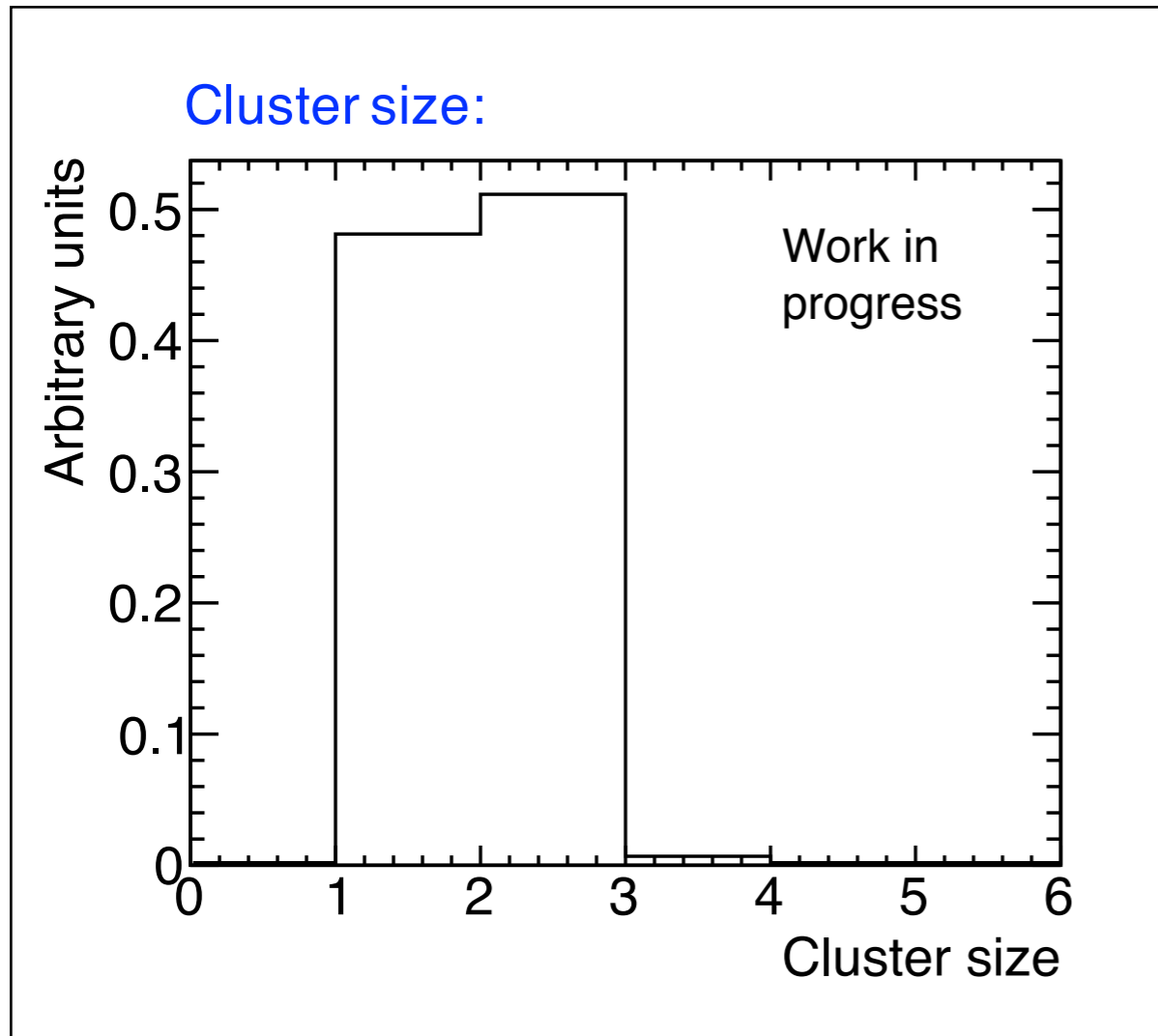
Example of χ^2 / ndof distribution:



Cluster size and spatial resolution for $V_{\text{bias}} = 6 \text{ V}$



Results for pitch of $28 \mu\text{m}$ and bias voltage of 6 V :



- Significant charge sharing for small pitch:
 - Cluster size of ~ 1.5
 - Position reconstruction improves with respect to binary expectation of $\sim 8 \mu\text{m}$ (η -correction applied):
 - Single point resolution $\sim 4.6 \mu\text{m}$ (telescope track resolution of $\sim 2 \mu\text{m}$ unfolded)

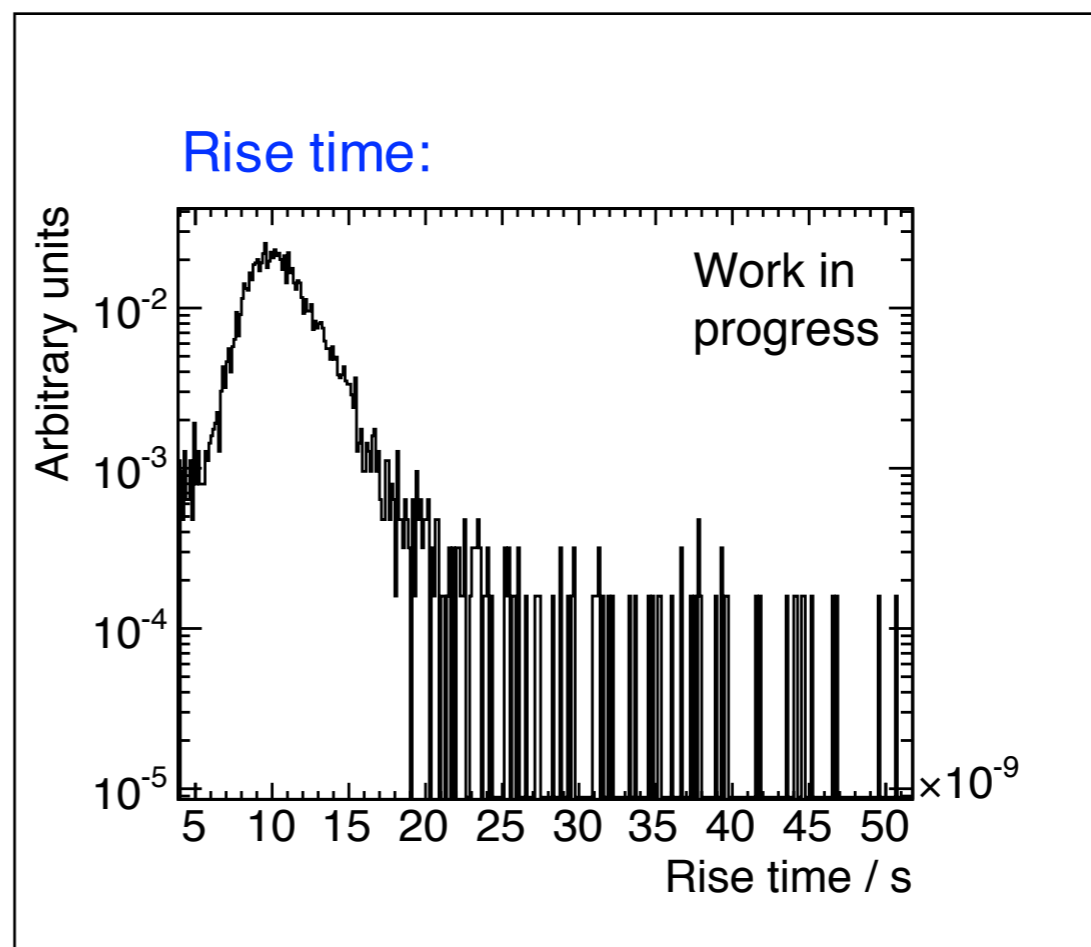
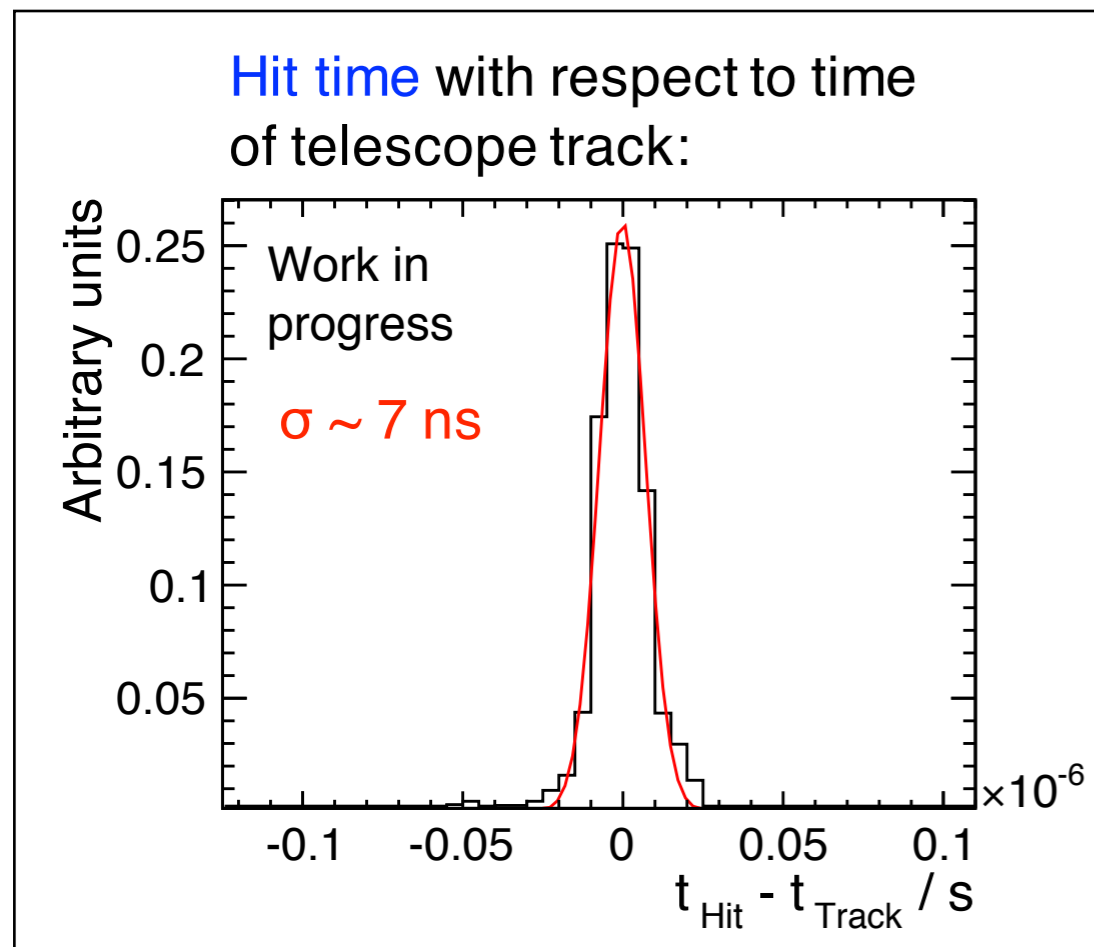
Hit time resolution and rise time for $V_{\text{bias}} = 6 \text{ V}$



Definition of timing observables:

- Use **first pixel in cluster** associated to telescope track to extract timing
→ Minimise impact from charge sharing

Results for pitch of $28 \mu\text{m}$ and bias voltage of 6 V :

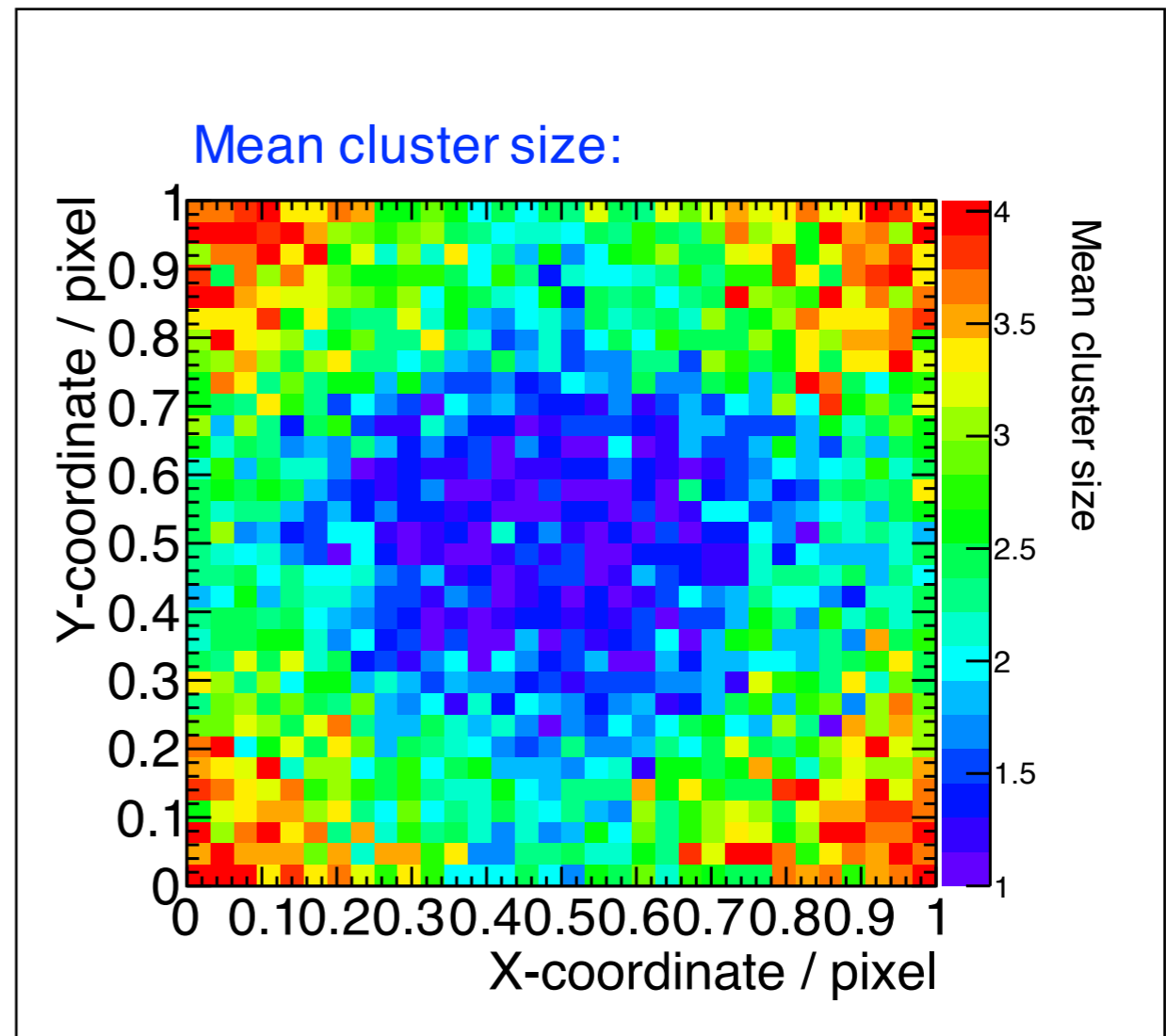
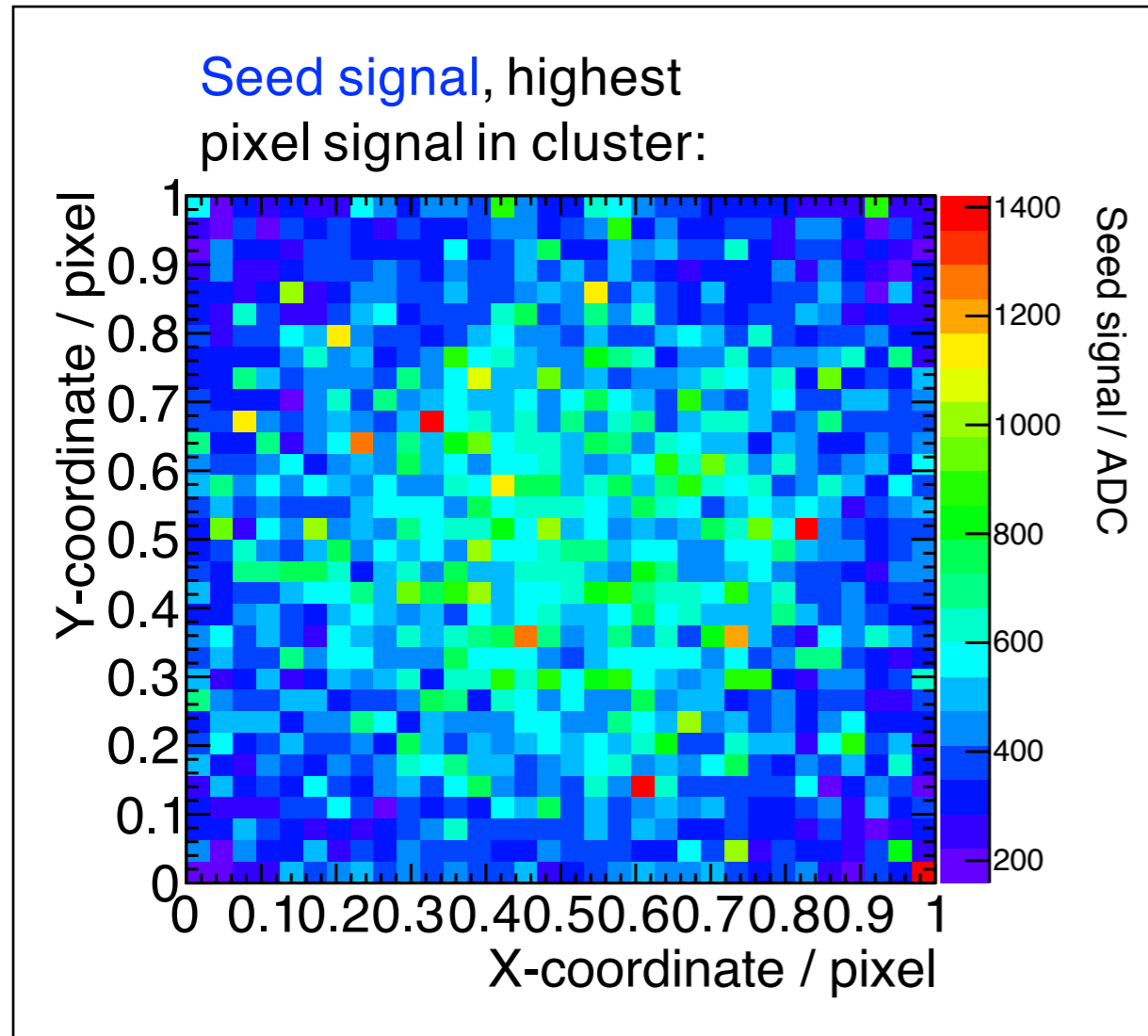


- Hit time relevant for CLIC to achieve time slicing of 10 ns :
→ **Hit time resolution of $\sim 7 \text{ ns}$**
- Rise time interesting to study technology:
→ Expect slower contributions from charge sharing and / or non depleted regions

In-pixel studies at $V_{\text{bias}} = 6 \text{ V}$



Results for pitch of $28 \mu\text{m}$ and bias voltage of 6 V :



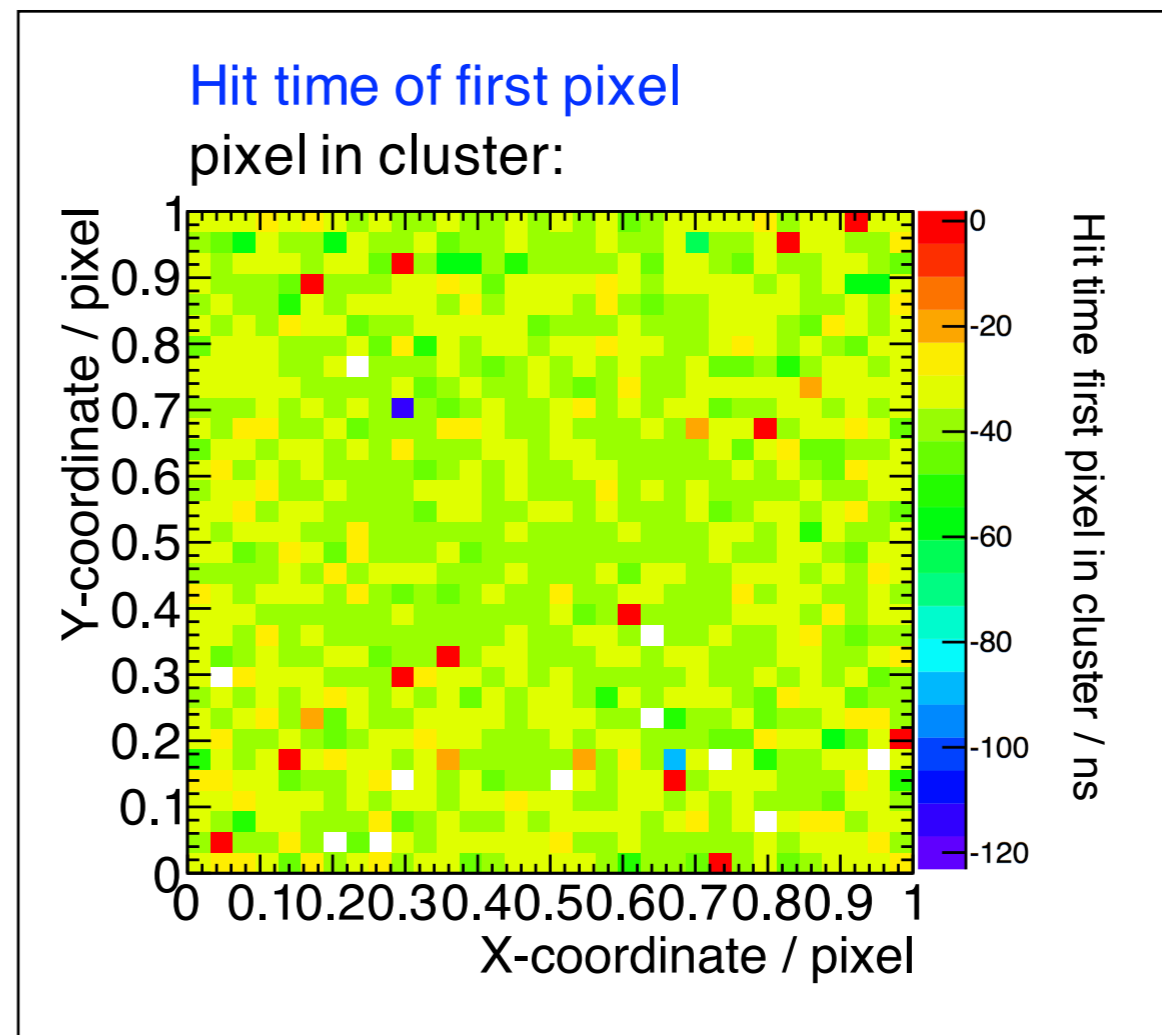
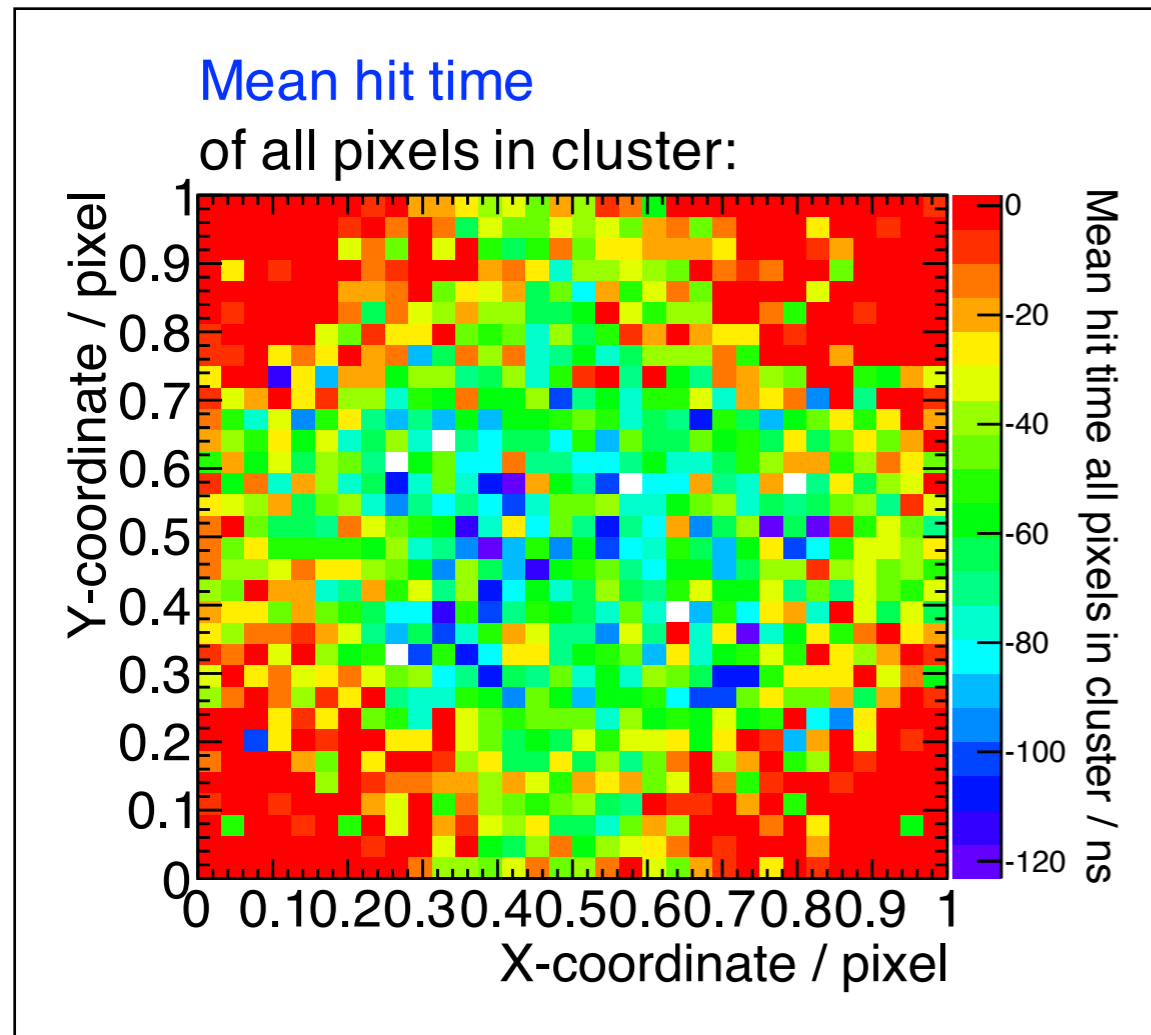
Work in progress

- Seed signal drops at pixel edges and pixel corners due to charge sharing:
 - Lowest cluster sizes in pixel center
 - Intermediate cluster sizes at pixel edges
 - Highest cluster size in pixel corners

In-pixel studies at $V_{\text{bias}} = 6 \text{ V}$



Results for pitch of $28 \mu\text{m}$ and bias voltage of 6 V :



Blue =
early hits

Red =
late hits

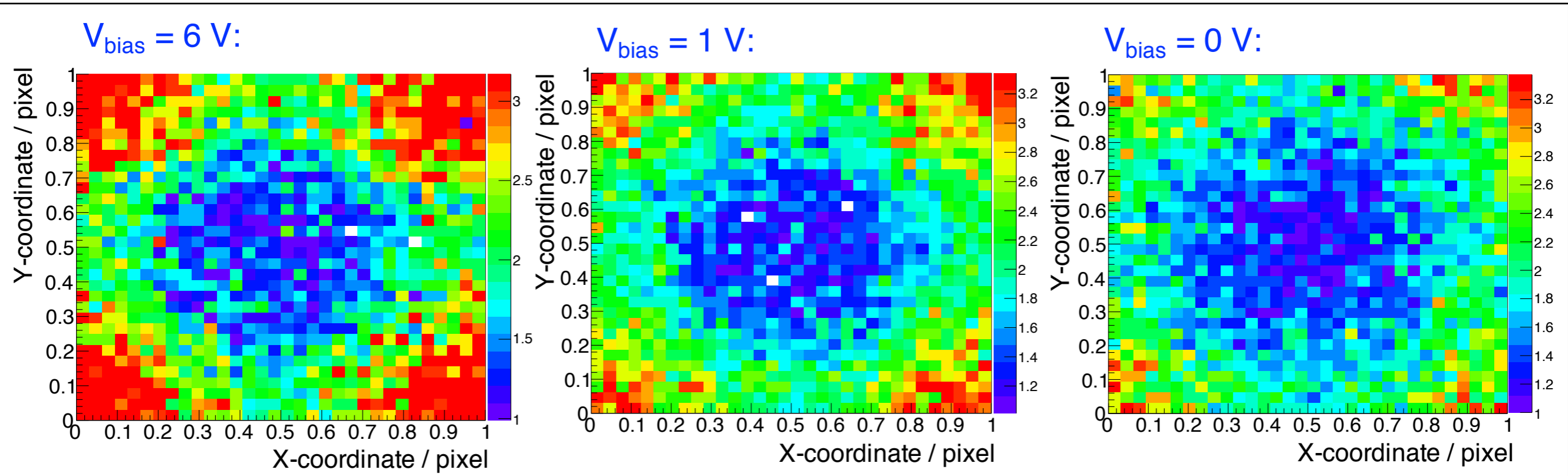
Work in
progress

- Mean hit time of all pixels in cluster interesting to study dependency of timing in pixel cell on charge sharing:
 - Large variations according to charge sharing at pixel edges and pixel corners
- Hit time of first pixel in cluster interesting to study in pixel performance of time slicing:
 - Small variations in pixel cell → no significant dependency on charge sharing
 - Good timing resolution

In-pixel studies for different bias voltage



Mean cluster size in pixel cell for a pitch of 28 μm and different bias voltages:



Work in progress

- More charge sharing for higher bias voltages due to:
 - Larger depleted region for higher bias voltages
 - Larger signal for higher bias voltages
- Higher cluster size in pixel corners for higher bias voltage

Summary & outlook

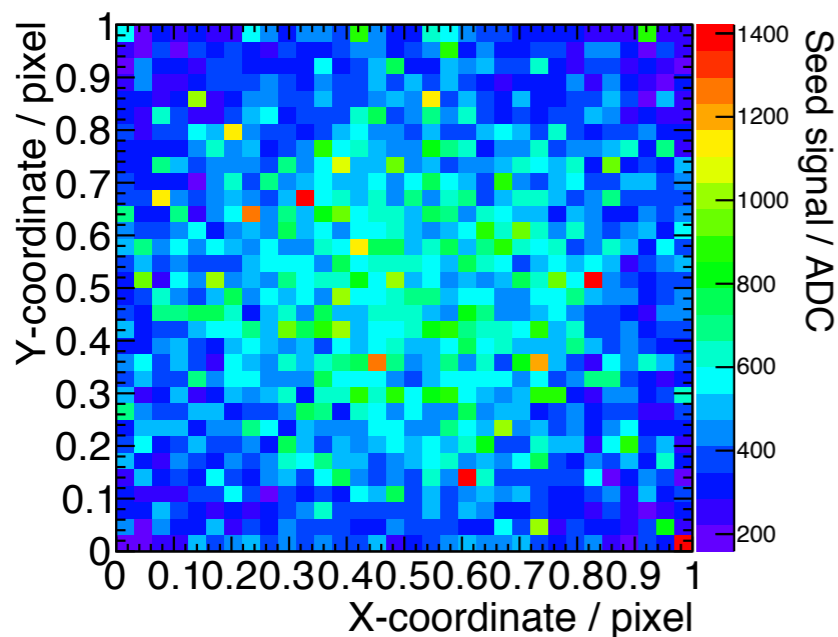
- ALICE investigator chip interesting to study full analogue performance of monolithic technology chosen by ALICE with respect to CLIC requirements
- Integration of ALICE investigator chip in CLICdp Timepix3 telescope
- Single point resolution of $\sim 5 \mu\text{m}$
- Hit time resolution of $\sim 7 \text{ ns}$
(*Test-chip with external readout*)
- Charge sharing and timing investigated on sub-pixel level
- Efficiency measurement and study of different pixel layouts currently ongoing

BACKUP

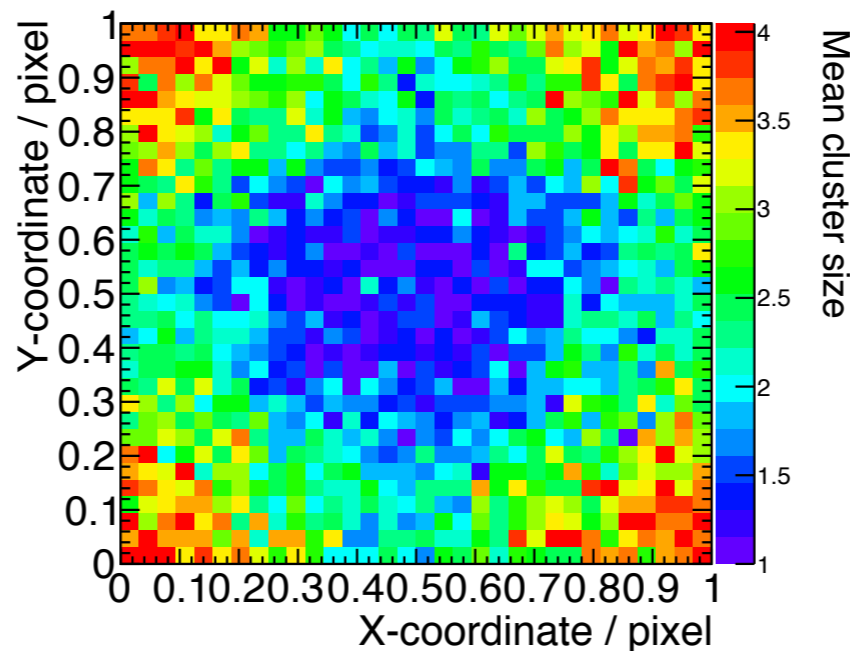
In-pixel timing at $V_{\text{bias}} = 6 \text{ V}$



Seed signal = highest pixel signal in cluster:



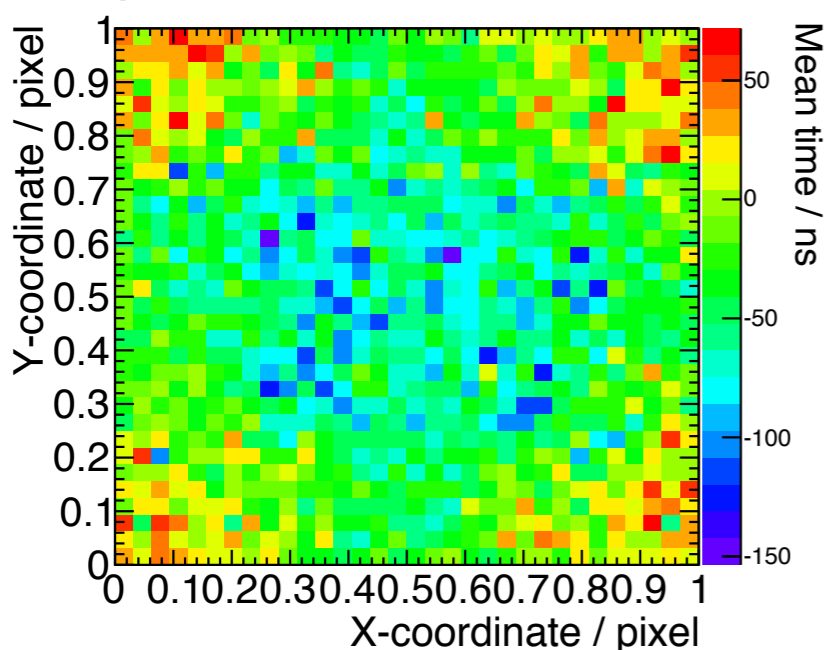
Mean cluster size:



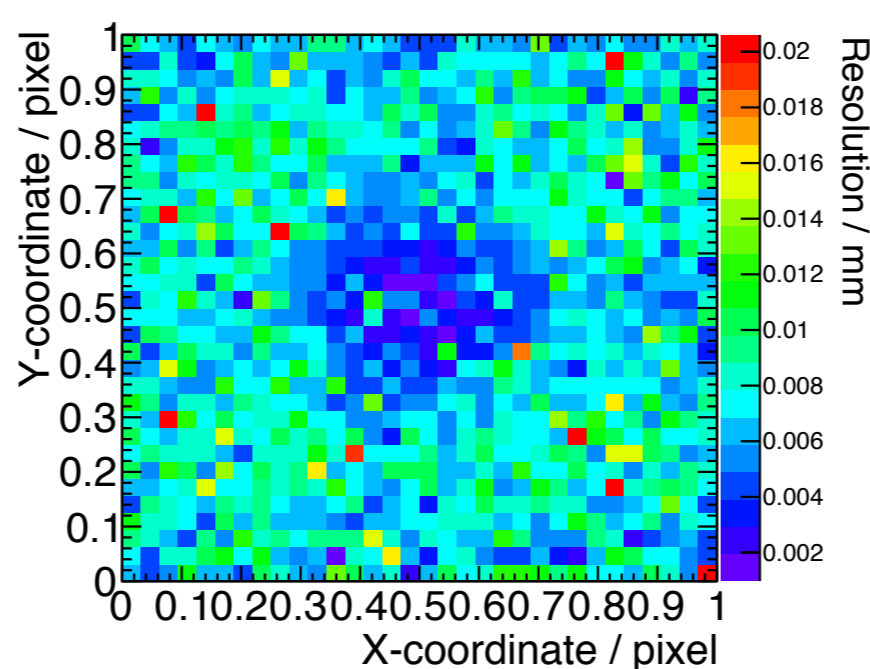
Observe behavior expected from charge sharing with in-pixel accuracy:

- Seed signal
- Cluster size
- Resolution
- Timing

Mean time of all pixels in cluster:

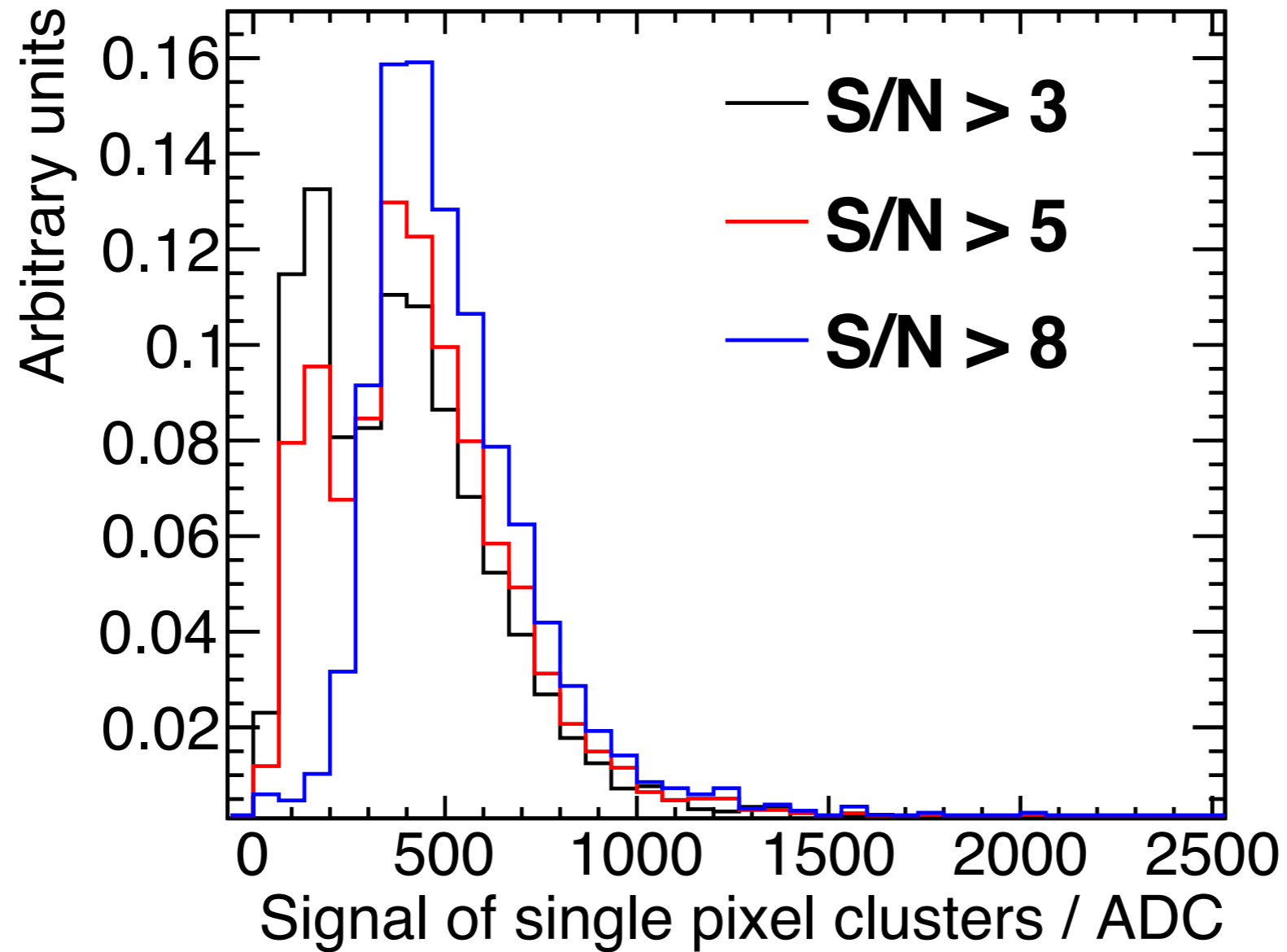


Resolution:



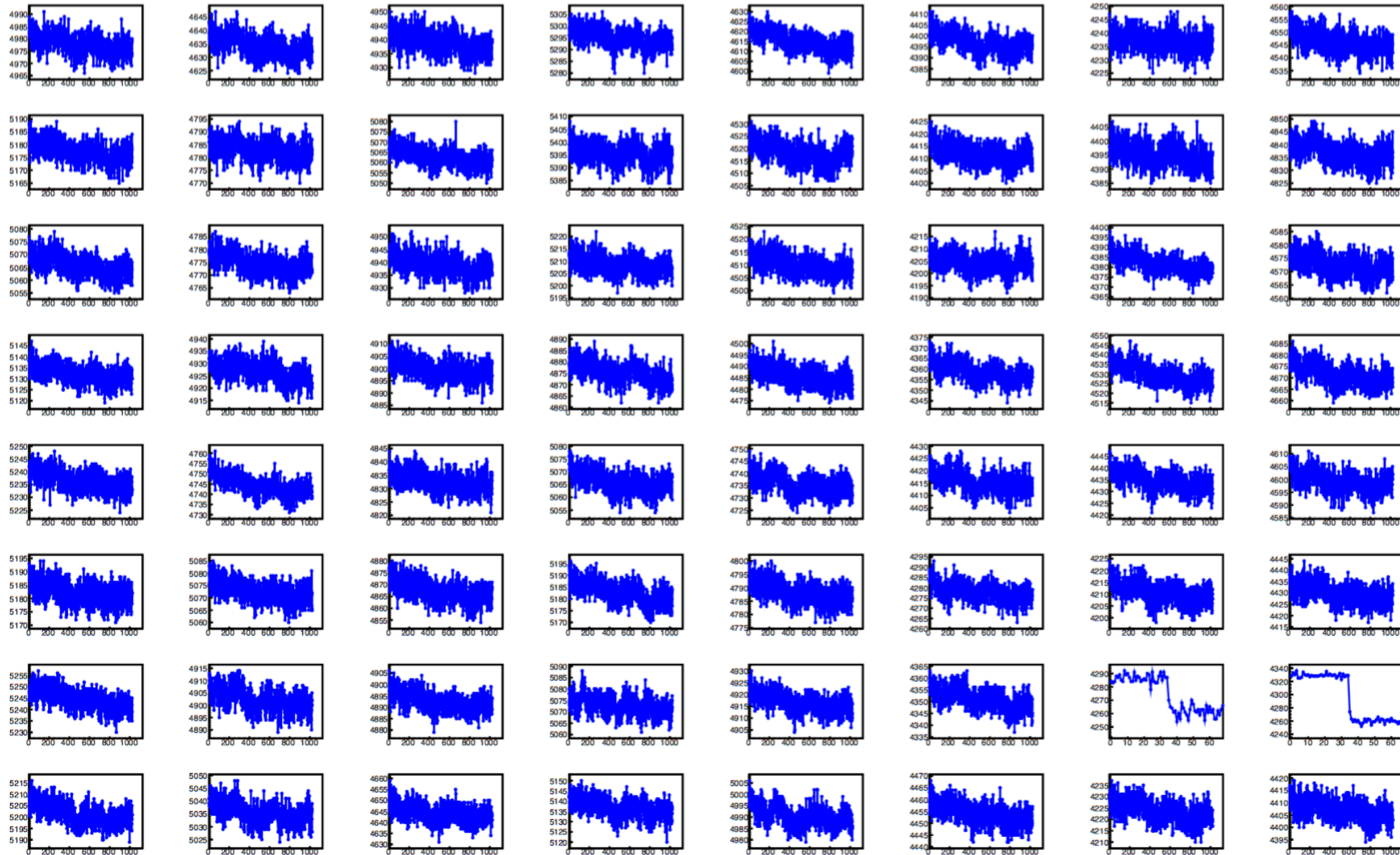
↓
Analysis performs on great level of detail for observables we want to study

Cut on signal/noise (S/N)



- Select pixels with $S/N > 8$
- Note cut on DAQ level frames are only readout if at least one pixel has $S/N > 10$

Common mode correction



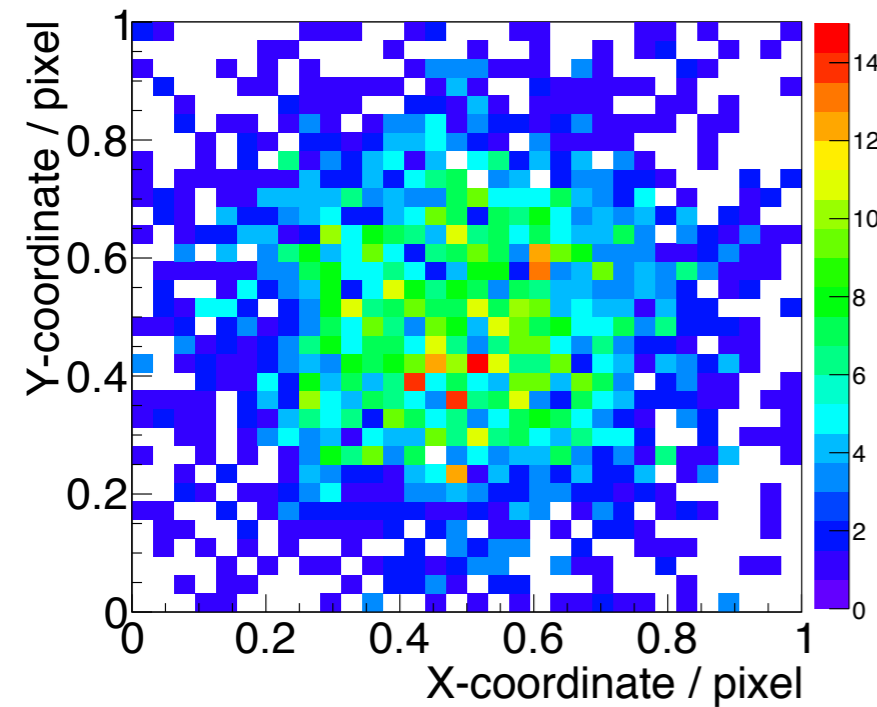
- Common mode visible in all pixels, different for different events
- Correct on event basis:
 - Use all pixels with no hit to calculate common mode
 - Use all pixels with a hit → subtract common mode → use for further analysis

In-pixel studies at $V_{\text{bias}} = 6 \text{ V}$

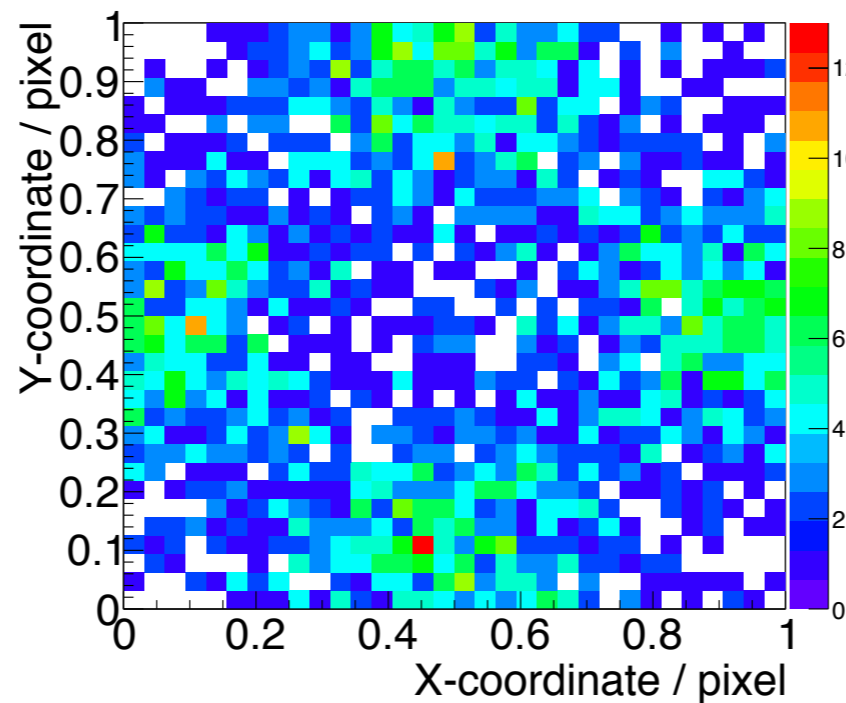


Hit map in pixel cell for different cluster sizes:

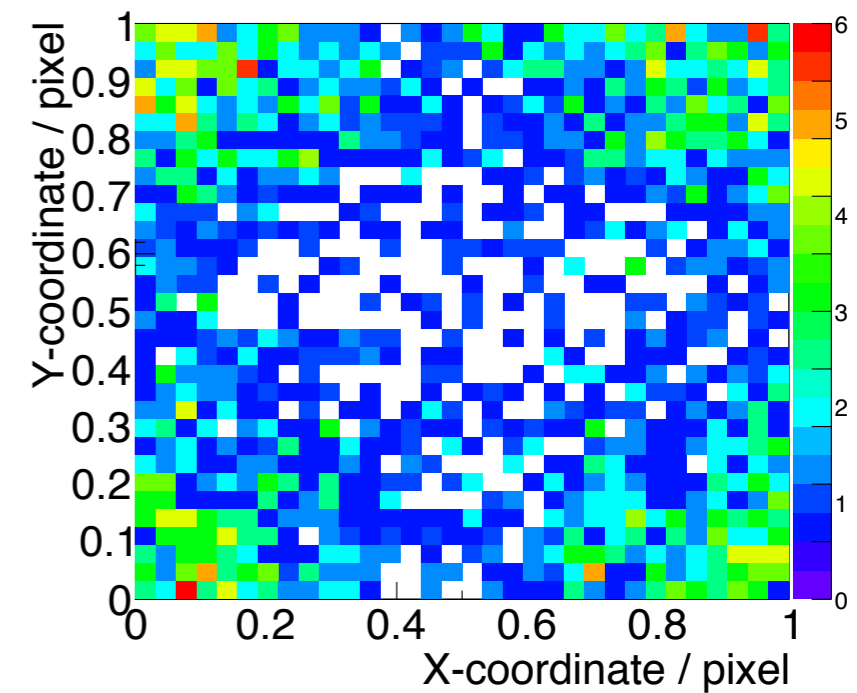
1-pixel hit:



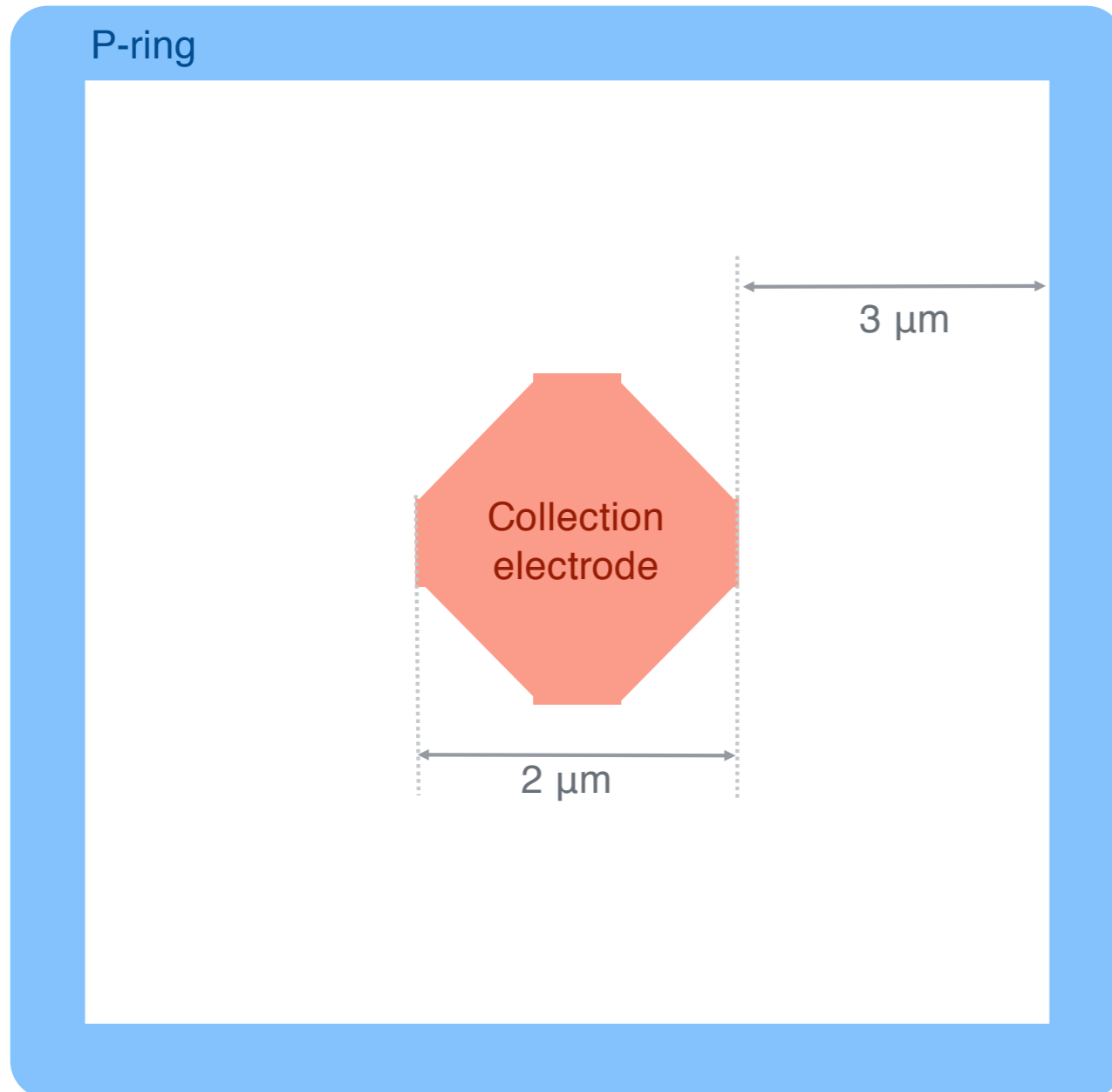
2-pixel hit:



2-pixel hit:



Pixel layout of studied mini-matrix:



- Study mini-matrix with pitch of $28\ \mu\text{m}$
- CMOS transistors outside p-ring
→ Shielded by deep n-wells
- Data recorded during June test-beam period
→ Investigator running in self triggering mode
- Add busy signal from investigator to telescope planes in current test-beam (ongoing) to perform efficiency measurements

Aim for analysed data presented in this talk:

- Study spatial and timing resolution

Pixel schematic

